

Is Now Part of



## **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.

# 

**FDS6679** 

FAIRCHILD

### 30 Volt P-Channel PowerTrench<sup>®</sup> MOSFET

#### **General Description**

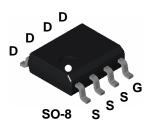
This P-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers, and battery chargers.

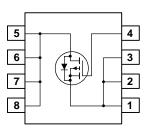
These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable R<sub>DS(ON)</sub> specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

#### **Features**

- $-13 \text{ A}, -30 \text{ V}. \text{ R}_{\text{DS(ON)}} = 9 \text{ m}\Omega @ \text{V}_{\text{GS}} = -10 \text{ V}$  $R_{DS(ON)} = 13 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Extended  $V_{GSS}$  range (±25V) for battery applications
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- · High power and current handling capability





#### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

| Symbol           | Parameter  |           | Ratings     | Units |
|------------------|--|-----------|-------------|-------|
| V <sub>DSS</sub> | Drain-Source Voltage                             |           | -30         | V     |
| V <sub>GSS</sub> | Gate-Source Voltage                              |           | ±25         | V     |
| I <sub>D</sub>   | Drain Current – Continuous                       | (Note 1a) | -13         | A     |
|                  | - Pulsed   |           | -50         |       |
| P <sub>D</sub>   | Power Dissipation for Single Operation           | (Note 1a) | 2.5         | W     |
|                  |  | (Note 1b) | 1.2         |       |
|                  |  | (Note 1c) | 1.0         |       |
| $T_J, T_{STG}$   | Operating and Storage Junction Temperature Range |           | -55 to +175 | °C    |
| Therma           | I Characteristics                                |           |             |       |
| $R_{\theta JA}$  | Thermal Resistance, Junction-to-Ambient          | (Note 1a) | 50          | °C/W  |
| $R_{\theta JC}$  | Thermal Resistance, Junction-to-Case             | (Note 1)  | 25          | °C/W  |

#### Package Marking and Ordering Information

| Device Marking | Device  | Reel Size | Tape width | Quantity   |
|----------------|---------|-----------|------------|------------|
| FDS6679        | FDS6679 | 13"       | 12mm       | 2500 units |

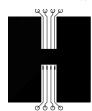
©2005 Fairchild Semiconductor Corporation

FDS6679

| Symbol                                      | Parameter   | Test Conditions   | Min | Тур              | Max           | Units |
|---|---|---|-----|------------------|---------------|-------|
| Off Char                                    | acteristics                                       |   |     |                  |               |       |
| BV <sub>DSS</sub>                           | Drain–Source Breakdown Voltage                    | $V_{GS} = 0 V, I_D = -250 \mu A$  | -30 | İ                |               | V     |
| <u>ΔBV<sub>DSS</sub></u><br>ΔT <sub>J</sub> | Breakdown Voltage Temperature<br>Coefficient      | $I_D = -250 \ \mu$ A, Referenced to 25°C  |     | -23              |               | mV/°C |
| IDSS  | Zero Gate Voltage Drain Current                   | $V_{DS} = -24 \text{ V},  V_{GS} = 0 \text{ V}$   |     |                  | -1            | μA    |
| I <sub>GSS</sub>                            | Gate-Body Leakage                                 | $V_{GS} = \pm 25 \text{ V}, \qquad V_{DS} = 0 \text{ V}$  |     |                  | ±100          | nA    |
| On Char                                     | acteristics (Note 2)                              |   |     |                  |               |       |
| V <sub>GS(th)</sub>                         | Gate Threshold Voltage                            | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$   | -1  | -1.6             | -3            | V     |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$      | Gate Threshold Voltage<br>Temperature Coefficient | $I_D = -250 \ \mu$ A, Referenced to $25^{\circ}$ C  |     | 5                |               | mV/°C |
| R <sub>DS(on)</sub>                         | Static Drain–Source<br>On–Resistance              | $V_{GS} = -10 \text{ V},  I_D = -13 \text{ A}$<br>$V_{GS} = -4.5 \text{ V},  I_D = -11 \text{ A}$<br>$V_{GS} = -10 \text{ V}, I_D = -13 \text{ A}, T_J = 125^{\circ}\text{C}$ |     | 7.3<br>10<br>9.5 | 9<br>13<br>13 | mΩ    |
| I <sub>D(on)</sub>                          | On-State Drain Current                            | $V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$  | -50 |                  |               | Α     |
| <b>g</b> <sub>FS</sub>                      | Forward Transconductance                          | $V_{DS} = -5 V$ , $I_{D} = -13 A$   |     | 44               |               | S     |
| Dynamic                                     | c Characteristics                                 |   |     |                  |               |       |
| Ciss  | Input Capacitance                                 | $V_{DS} = -15 V$ , $V_{GS} = 0 V$ ,   |     | 3939             |               | pF    |
| Coss  | Output Capacitance                                | f = 1.0 MHz   |     | 972              |               | pF    |
| C <sub>rss</sub>                            | Reverse Transfer Capacitance                      |   |     | 498              |               | pF    |
| Switchin                                    | g Characteristics (Note 2)                        |   |     |                  |               |       |
| t <sub>d(on)</sub>                          | Turn–On Delay Time                                | $V_{DD} = -15 V$ , $I_D = -1 A$ ,   |     | 19               | 34            | ns    |
| tr  | Turn–On Rise Time                                 | $V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$   |     | 10               | 20            | ns    |
| t <sub>d(off)</sub>                         | Turn-Off Delay Time                               |   |     | 110              | 176           | ns    |
| t <sub>f</sub>                              | Turn–Off Fall Time                                |   |     | 65               | 104           | ns    |
| Qq  | Total Gate Charge                                 | $V_{DS} = -15 \text{ V}, \qquad I_{D} = -13 \text{ A},$   |     | 71               | 100           | nC    |
| Q <sub>gs</sub>                             | Gate–Source Charge                                | $V_{GS} = -10 \text{ V}$  |     | 12               |               | nC    |
| Q <sub>gd</sub>                             | Gate–Drain Charge                                 | 1   |     | 15               |               | nC    |
| Drain-Se                                    | ource Diode Characteristics                       | and Maximum Ratings   |     |                  |               |       |
| Is  | Maximum Continuous Drain–Source                   |   |     |                  | -2.1          | А     |
| V <sub>SD</sub>                             | Drain–Source Diode Forward<br>Voltage             | $V_{GS} = 0 V$ , $I_S = -2.1 A$ (Note 2)  |     | -0.7             | -1.2          | V     |

Notes:

1.  $R_{\theta,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta,CA}$  is guaranteed by design while  $R_{\theta,CA}$  is determined by the user's board design.



a) 50°C/W (10 sec) 62.5°C/W steady state when mounted on a 1in<sup>2</sup> pad of 2 oz copper

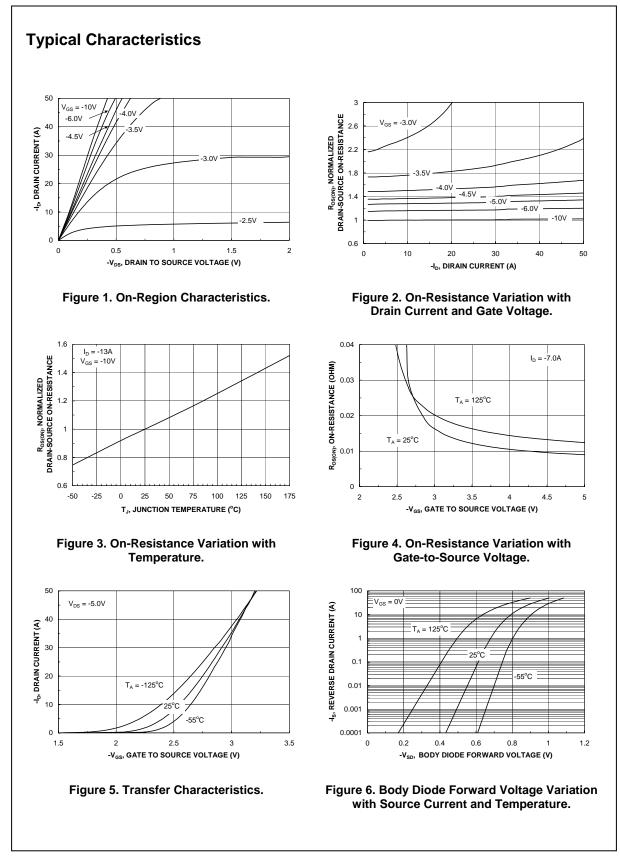


b) 105°C/W when mounted on a .04 in<sup>2</sup> pad of 2 oz copper

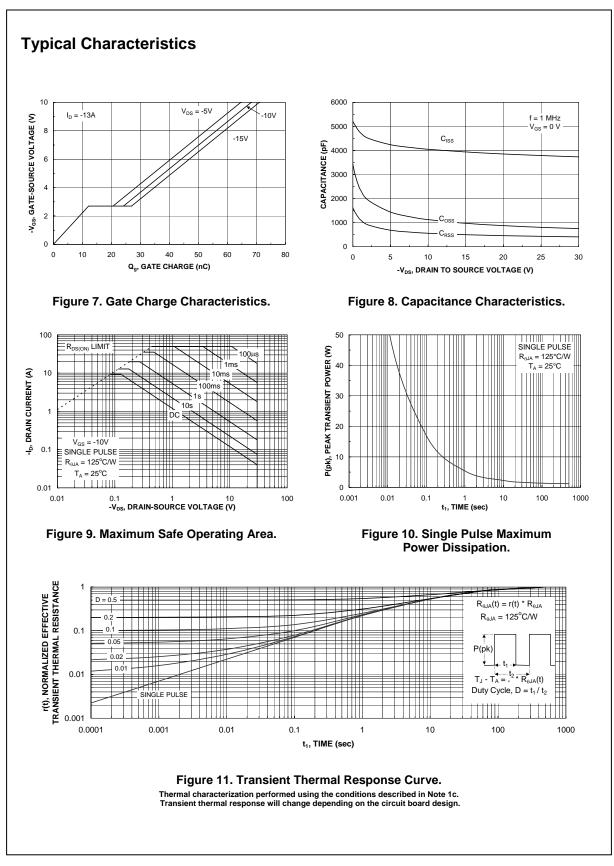
c) 125°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%



# FDS6679



FDS6679

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

## **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi:

FDS6679